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April 1st, 2010
Renesas Electronics Corporation

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RD74LVC273B

Octal D-type Flip-Flops with Clear

REJ03D0323-0100Z

Rev.1.00

Jun. 16, 2004

Description

The RD74LVC273B has eight edge trigger D-type flip-flops with clear in a 20-pin package. Data on the D input having the specified setup and hold times is transferred to the Q output on the low to high transition of the clock input. The clear input when low, sets all outputs to a low state. Low-voltage and high-speed operation is suitable for battery-powered products (e.g., notebook computers), and the low-power consumption extends the battery life.

Features

- $V_{CC} = 1.65\text{ V to }5.5\text{ V}$
- All inputs $V_{IH}(\text{Max.}) = 5.5\text{ V} (@V_{CC} = 0\text{ V to }5.5\text{ V})$
- All outputs $V_{OUT}(\text{Max.}) = 5.5\text{ V} (@V_{CC} = 0\text{ V})$
- Typical V_{OL} ground bounce $< 0.8\text{ V} (@V_{CC} = 3.3\text{ V}, T_a = 25^\circ\text{C})$
- Typical V_{OH} undershoot $> 2.0\text{ V} (@V_{CC} = 3.3\text{ V}, T_a = 25^\circ\text{C})$
- High Output current
 - $\pm 4\text{ mA} (@V_{CC} = 1.65\text{ V})$
 - $\pm 8\text{ mA} (@V_{CC} = 2.3\text{ V})$
 - $\pm 12\text{ mA} (@V_{CC} = 2.7\text{ V})$
 - $\pm 24\text{ mA} (@V_{CC} = 3.0\text{ V to }5.5\text{ V})$
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
RD74LVC273BFPEL	SOP-20 pin(JEITA)	FP-20DAV	FP	EL (2,000 pcs / reel)
RD74LVC273BTELL	TSSOP-20 pin	TTP-20DAV	T	ELL (2,000 pcs / reel)

Function Table

$\overline{\text{CLR}}$	Inputs		Output Q
	CLK	D	
L	X	X	L
H	↑	H	H
H	↑	L	L
H	↓	X	Q_0

Note: H: High level

L: Low level

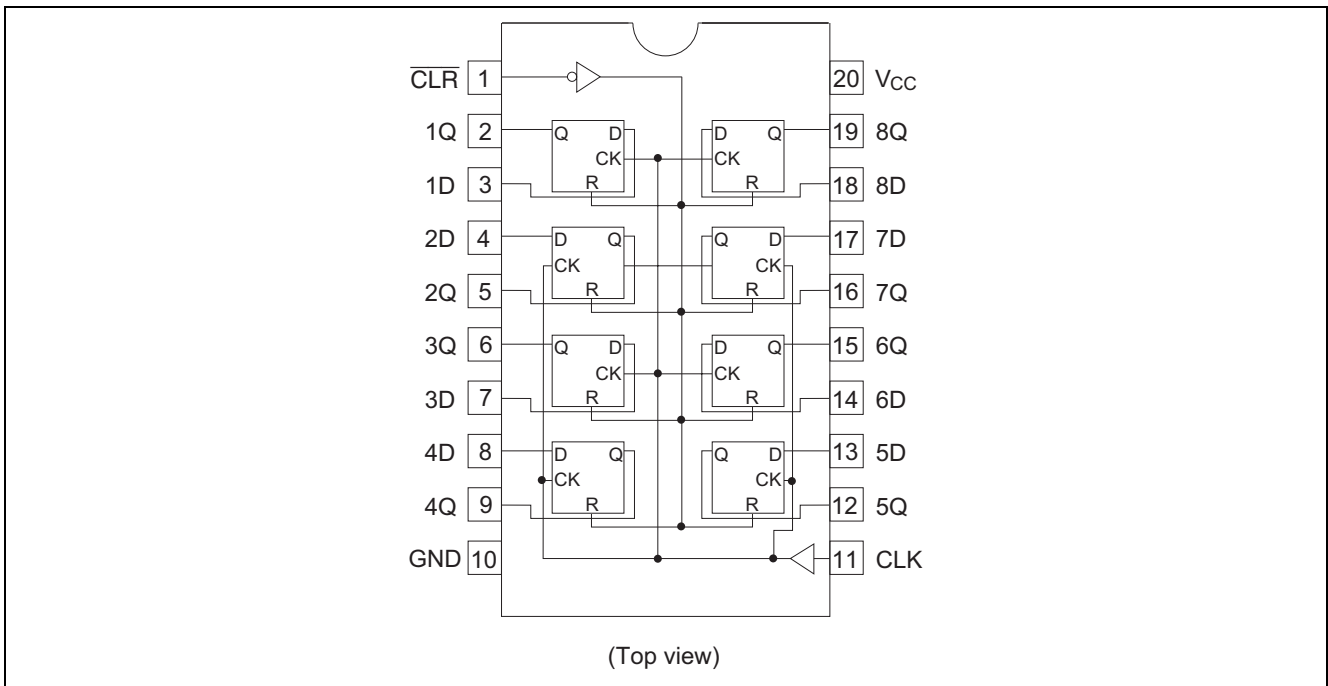
X: Immaterial

↑: Low to high transition

↓: High to low transition

Q_0 : Output level before the indicated steady state input conditions were established.

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	-0.5 to 7.0	V	
Input diode current	I_{IK}	-50	mA	$V_I = -0.5$ V
Input voltage	V_I	-0.5 to 7.0	V	
Output diode current	I_{OK}	-50	mA	$V_O = -0.5$ V
		50		$V_O = V_{CC} + 0.5$ V
Output voltage	V_O	-0.5 to $V_{CC} + 0.5$	V	Output "H" or "L"
		-0.5 to 7.0		V_{CC} : OFF
Output current	I_O	± 50	mA	
V_{CC} , GND current / pin	I_{CC} or I_{GND}	100	mA	
Storage temperature	T_{stg}	-65 to 150	$^{\circ}$ C	

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	1.5 to 5.5	V	Data hold
		1.65 to 5.5		At operation
Input/Output voltage	V_I	0 to 5.5	V	CLK, \overline{CLR} , D
	V_O	0 to V_{CC}		Output "H" or "L"
		0 to 5.5		V_{CC} : OFF
Operating temperature	T_a	-40 to 85	°C	
Output current	I_{OH}	-4	mA	$V_{CC} = 1.65\text{ V}$
		-8		$V_{CC} = 2.3\text{ V}$
		-12		$V_{CC} = 2.7\text{ V}$
		-24		$V_{CC} = 3.0\text{ V to }5.5\text{ V}$
	I_{OL}	4	mA	$V_{CC} = 1.65\text{ V}$
		8		$V_{CC} = 2.3\text{ V}$
		12		$V_{CC} = 2.7\text{ V}$
		24		$V_{CC} = 3.0\text{ V to }5.5\text{ V}$
Input rise / fall time* ¹	t_r / t_f	20	ns/V	$V_{CC} = 1.65\text{ V to }2.7\text{ V}$
		10		$V_{CC} = 3.0\text{ V to }5.5\text{ V}$

Note: 1. This item guarantees maximum limit when one input switches.
Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

Item	Symbol	V _{CC} (V)	Ta = -40 to 85°C		Unit	Test Conditions
			Min	Max		
Input voltage	V _{IH}	1.65 to 1.95	V _{CC} × 0.65	—	V	
		2.3 to 2.7	1.7	—		
		2.7 to 3.6	2.0	—		
		4.5 to 5.5	V _{CC} × 0.7	—		
	V _{IL}	1.65 to 1.95	—	V _{CC} × 0.35		
		2.3 to 2.7	—	0.7		
		2.7 to 3.6	—	0.8		
		4.5 to 5.5	—	V _{CC} × 0.3		
Output voltage	V _{OH}	1.65 to 5.5	V _{CC} - 0.2	—	V	I _{OH} = -100 μA
		1.65	1.2	—		I _{OH} = -4 mA
		2.3	1.7	—		I _{OH} = -8 mA
		2.7	2.2	—		I _{OH} = -12 mA
		3.0	2.4	—		
		3.0	2.2	—		I _{OH} = -24 mA
		4.5	3.8	—		
	V _{OL}	1.65 to 5.5	—	0.2		I _{OL} = 100 μA
		1.65	—	0.45		I _{OL} = 4 mA
		2.3	—	0.7		I _{OL} = 8 mA
		2.7	—	0.4		I _{OL} = 12 mA
		3.0	—	0.55		I _{OL} = 24 mA
		4.5	—	0.55		
Input current	I _{IN}	0 to 5.5	—	±5.0	μA	V _{IN} = 5.5 V or GND
Output leak current	I _{OFF}	0	—	±5.0	μA	V _{IN} /V _{OUT} = 5.5 V
Quiescent supply current	I _{CC}	2.7 to 3.6	—	±5.0	μA	V _{IN} = 3.6 V to 5.5 V
		2.7 to 5.5	—	5.0		V _{IN} = V _{CC} or GND
	ΔI _{CC}	2.7 to 3.6	—	500		V _{IN} = one input at (V _{CC} -0.6)V, other inputs at V _{CC} or GND

Switching Characteristics

Item	Symbol	V _{CC} (V)	Ta = -40 to 85°C			Unit	FROM (Input)	TO (Output)
			Min	Typ	Max			
Maximum clock frequency	f _{max}	1.8±0.15	—	—	55.0	MHz		
		2.5±0.2	—	—	95.0			
		2.7	—	—	150.0			
		3.3±0.3	—	—	150.0			
		5.0±0.5	—	—	150.0			
Propagation delay time	t _{PLH}	1.8±0.15	1.0	—	21.6	ns	CLK	Q
		2.5±0.2	1.0	—	10.5			
		2.7	1.0	—	8.5			
		3.3±0.3	1.5	—	7.5			
		5.0±0.5	1.0	—	6.0			
	t _{PHL}	1.8±0.15	1.0	—	21.6	ns	CLR	Q
		2.5±0.2	1.0	—	10.5			
		2.7	1.0	—	8.5			
		3.3±0.3	2.0	—	7.5			
		5.0±0.5	1.0	—	6.0			
Setup time	t _{SU}	1.8±0.15	6.0	—	—	ns		
		2.5±0.2	4.0	—	—			
		2.7	2.0	—	—			
		3.3±0.3	2.0	—	—			
		5.0±0.5	2.0	—	—			
Hold time	t _H	1.8±0.15	4.0	—	—	ns		
		2.5±0.2	2.0	—	—			
		2.7	1.5	—	—			
		3.3±0.3	1.5	—	—			
		5.0±0.5	1.5	—	—			
Pulse width	t _W	1.8±0.15	9.0	—	—	ns		
		2.5±0.2	4.0	—	—			
		2.7	3.3	—	—			
		3.3±0.3	3.3	—	—			
		5.0±0.5	3.3	—	—			
Between output pins skew*1	t _{OSLH} t _{OSHL}	1.8±0.15	—	—	—	ns		
		2.5±0.2	—	—	—			
		2.7	—	—	—			
		3.3±0.3	—	—	1.0			
		5.0±0.5	—	—	1.0			
Input capacitance	C _{IN}	3.3	—	4.0	—	pF		
Output capacitance	C _O	3.3	—	8.0	—	pF		

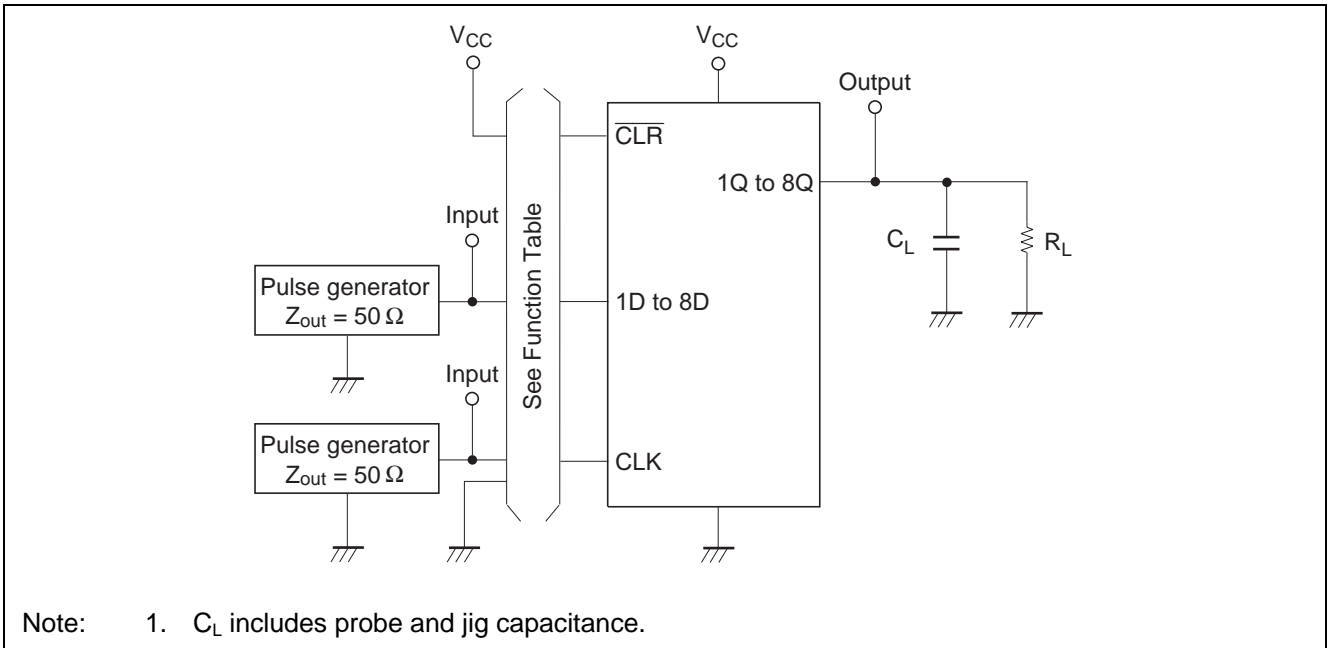
Note: 1. This parameter is characterized but not tested.

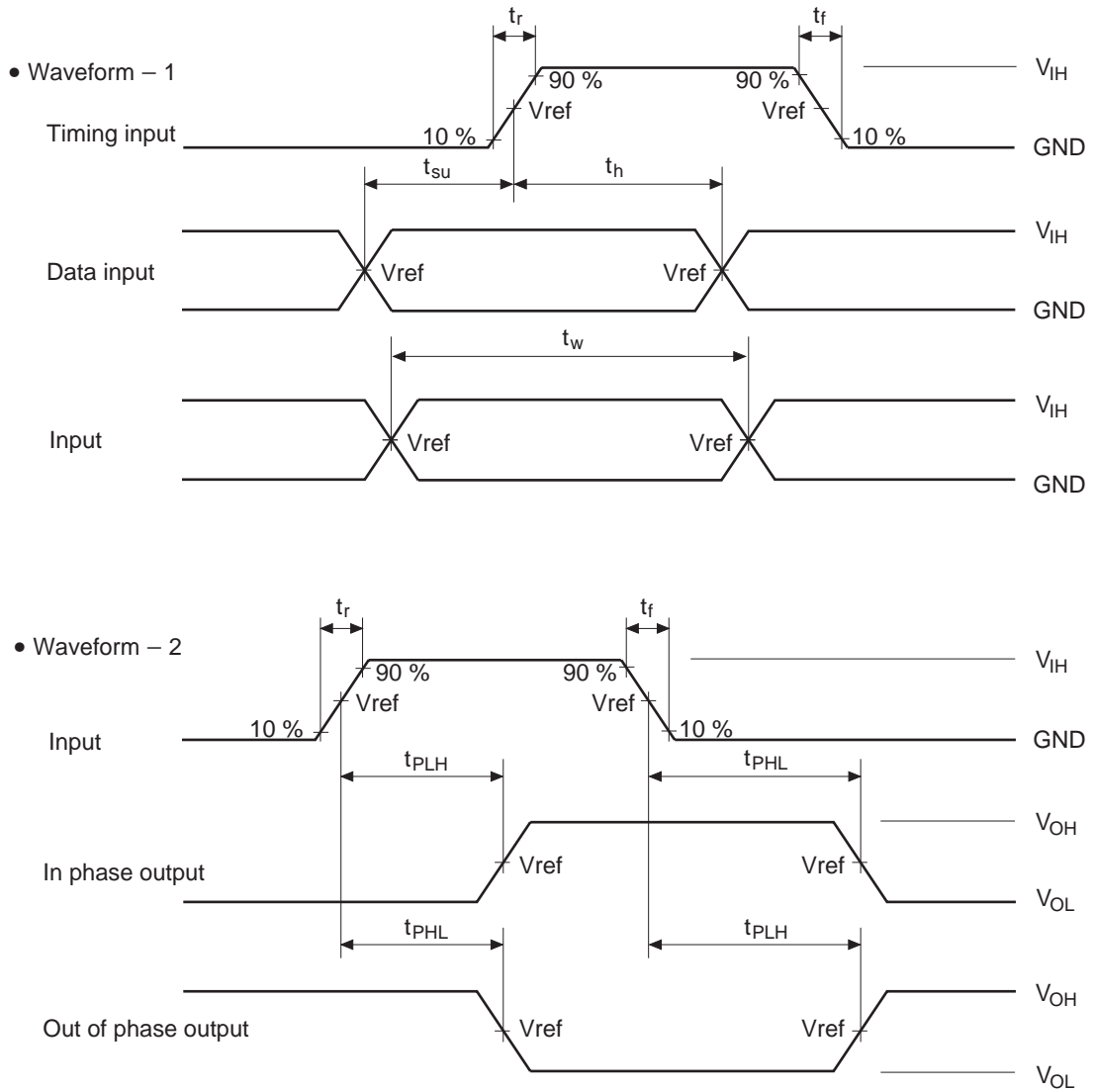
$$t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|$$

Operating Characteristics

Item	Symbol	V _{CC} = (V)	Ta = 25°C			Unit	Test Conditions
			Min	Typ	Max		
Power dissipation capacitance	C _{PD}	1.8	—	25	—	pF	f = 10 MHz
		2.5	—	26	—		
		3.3	—	28	—		
		5.0	—	32	—		

Test Circuit

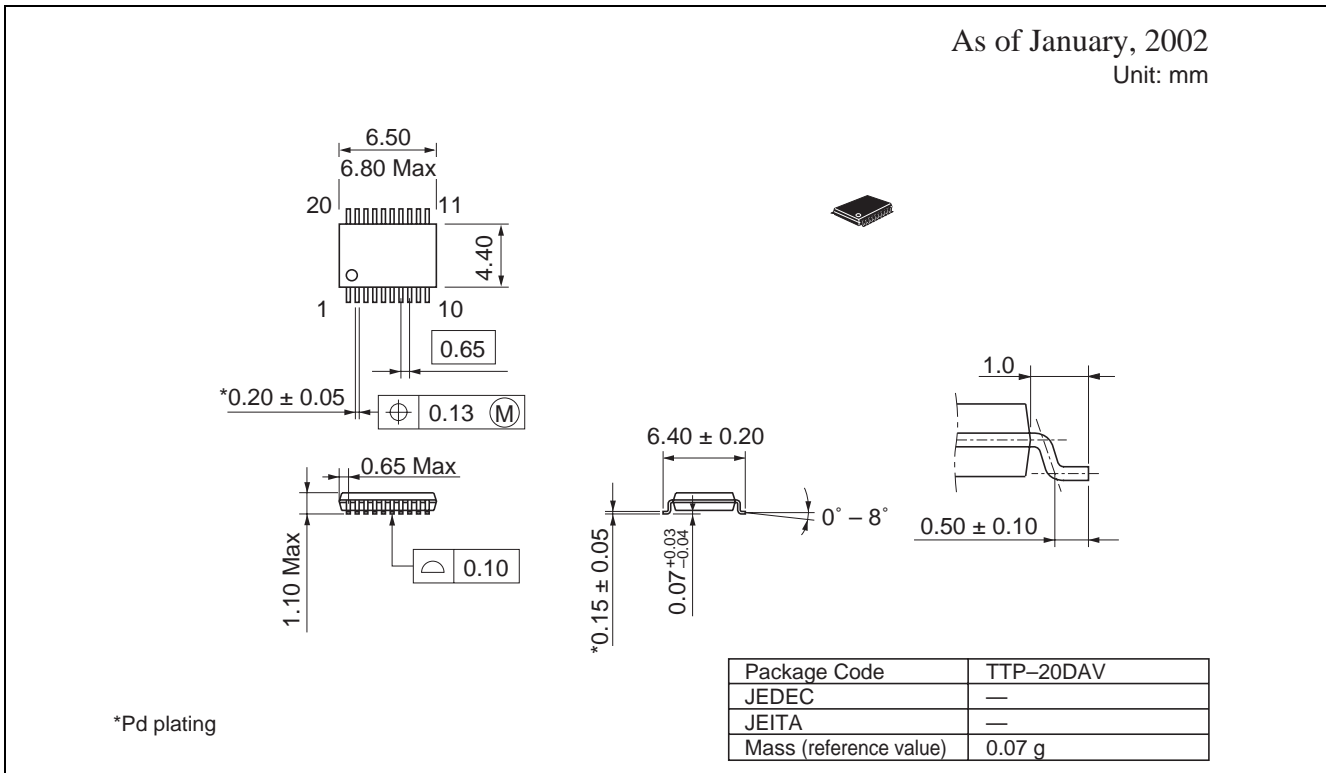
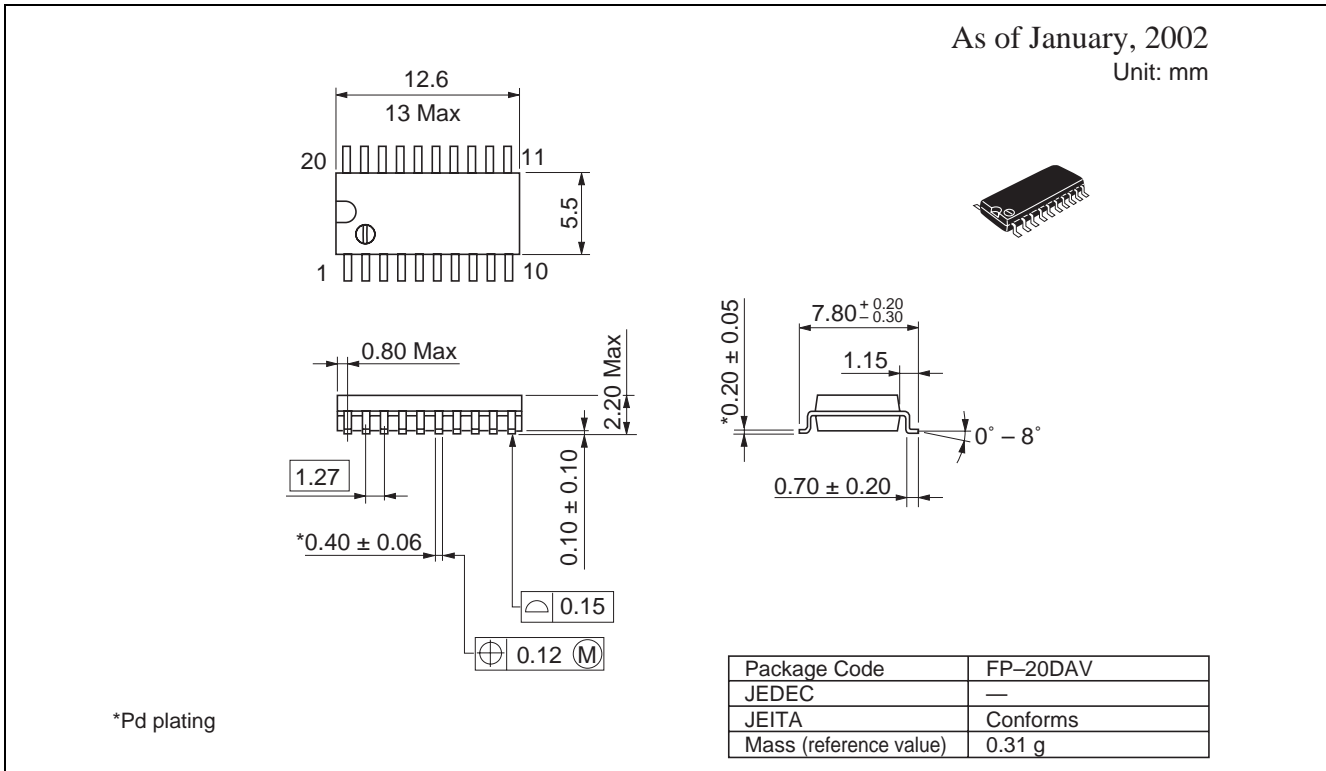




Vcc (V)	INPUTS		Vref	CL	RL
	V _{IH}	t _r / t _f			
Vcc = 1.8±0.15 V	Vcc	≤ 2 ns	1/2 Vcc	30 pF	1.0 kΩ
Vcc = 2.5±0.2 V	Vcc	≤ 2 ns	1/2 Vcc	30 pF	500 Ω
Vcc = 2.7 V	2.7 V	≤ 2.5 ns	1.5 V	50 pF	500 Ω
Vcc = 3.3±0.3 V	2.7 V	≤ 2.5 ns	1.5 V	50 pF	500 Ω
Vcc = 5.0±0.5 V	Vcc	≤ 2.5 ns	1/2 Vcc	50 pF	500 Ω

Notes: 1. Input waveform: PRR ≤ 10 MHz, duty cycle 50%.
 2. The output is measured one at a time with one transition per measurement.

Package Dimensions



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